

# Progress on $\text{Nb}_3\text{Sn}$ and $\text{V}_3\text{Si}$

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# $Nb_3Sn$

Tin Diffusion

Multilayer

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

Hybrid Process

6 GHz

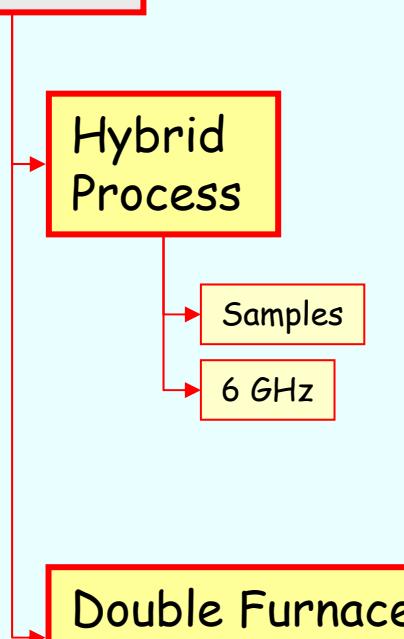
Samples

Samples  
6 GHz

Samples

6 GHz

Double Furnace System



$V_3Si$

Thermal  
diffusion

Thermal Diffusion  
+  
Plasma

Samples

6 GHz cavities

Samples

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Liquid Sn Diffusion

$\text{Nb}_3\text{Sn}$  can be obtained using different techniques:

- Bronze Process,
- Vapor Sn diffusion (Wuppertal),
- Liquid Phase Diffusion



Annealing

- No nucleation sites on Nb are required
- Fast growth of  $\text{Nb}_3\text{Sn}$  layer

$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

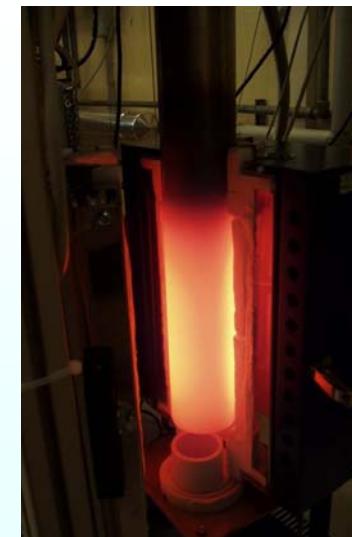
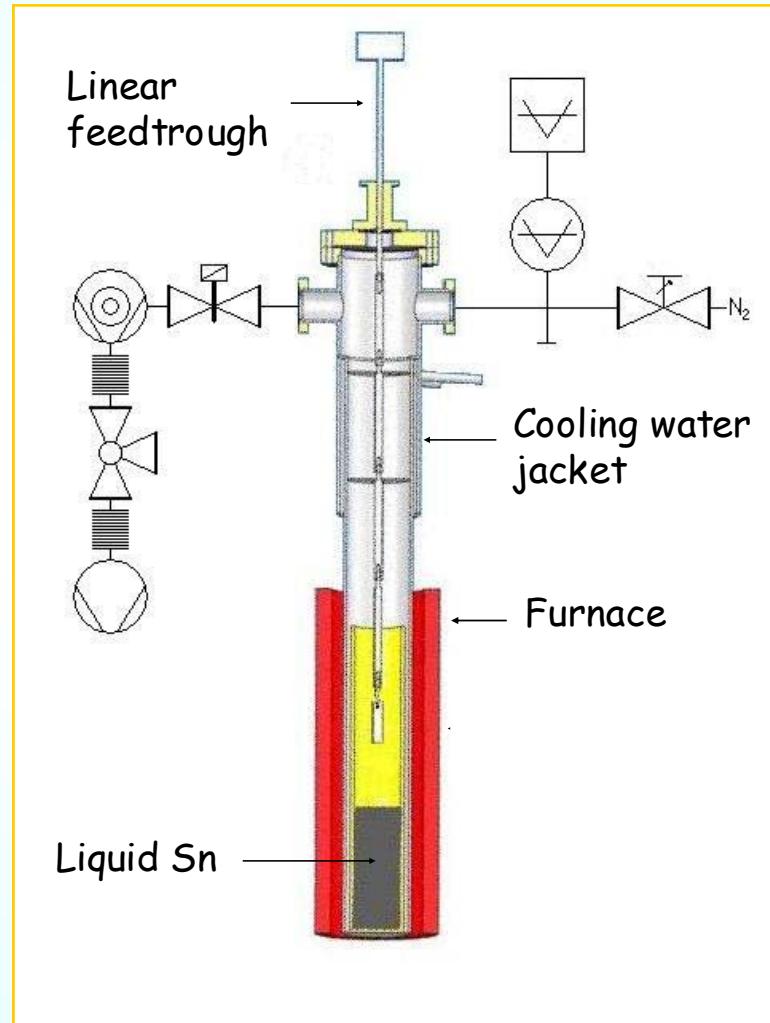
$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Liquid Sn Diffusion



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Hybrid Process

Cornell Workshop

Peking Workshop

Peking Workshop

*1 step*

*2 steps*

Now:  
*Hybrid*

Sn vapor  
Annealing

Vacuum  
Annealing

Sn vapor Annealing  
+  
Vacuum Annealing

- residual Sn
- spurious phases

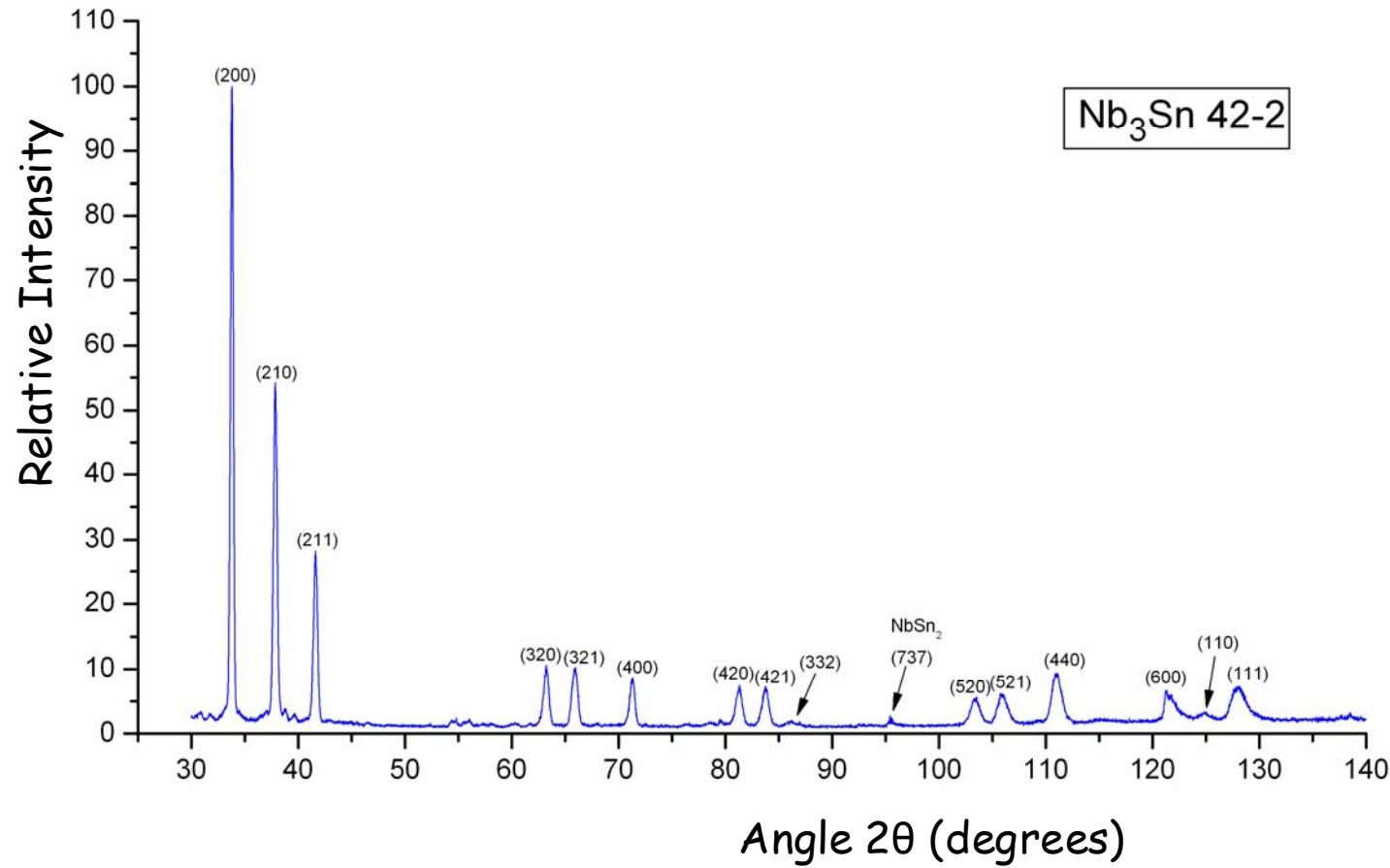
- low  $T_c$ s
- spurious phases

Good  $T_c$ s,  
No residual Sn,  
No spurious phases

$\text{Nb}_3\text{Sn}$
Liquid Sn diffusion
Mechanical Plating
Double Magnetron
Post Magnetron
$\text{V}_3\text{Si}$
Thermal diffusion
Thermal Diffusion + Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Hybrid Process: Samples



$\text{Nb}_3\text{Sn}$

Liquid Sn  
diffusion

Mechanical  
Plating

Double  
Magnetron

Post  
Magnetron

$\text{V}_3\text{Si}$

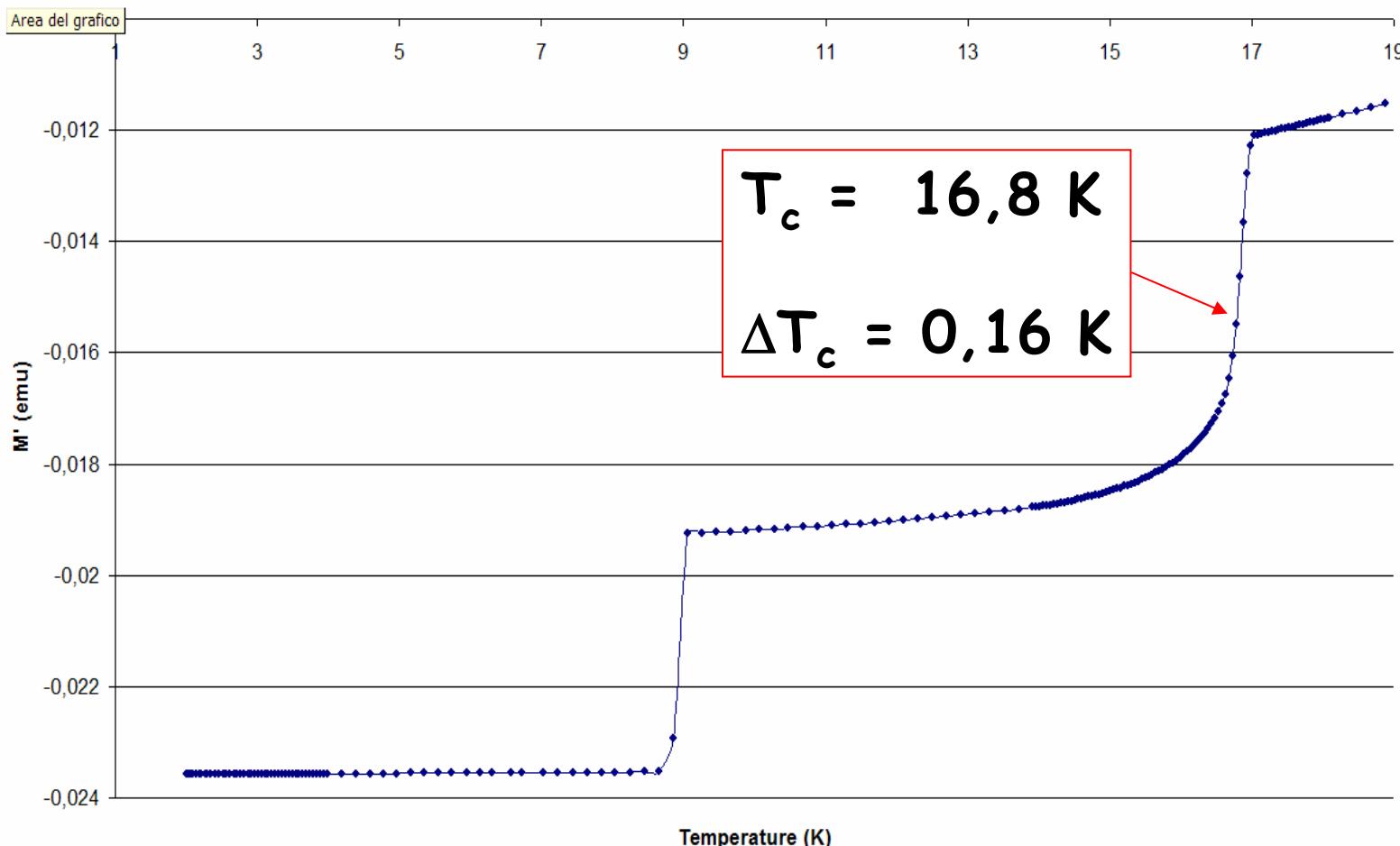
Thermal  
diffusion

Thermal  
Diffusion  
+  
Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Hybrid Process: Samples

$T = 975^\circ \text{ C}$ ,  $t_{\text{Dipp}} = 30'$ ,  $\text{Ann}_{\text{Sn}} t = 2\text{h}$ ,  $\text{Ann}_V t =$



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

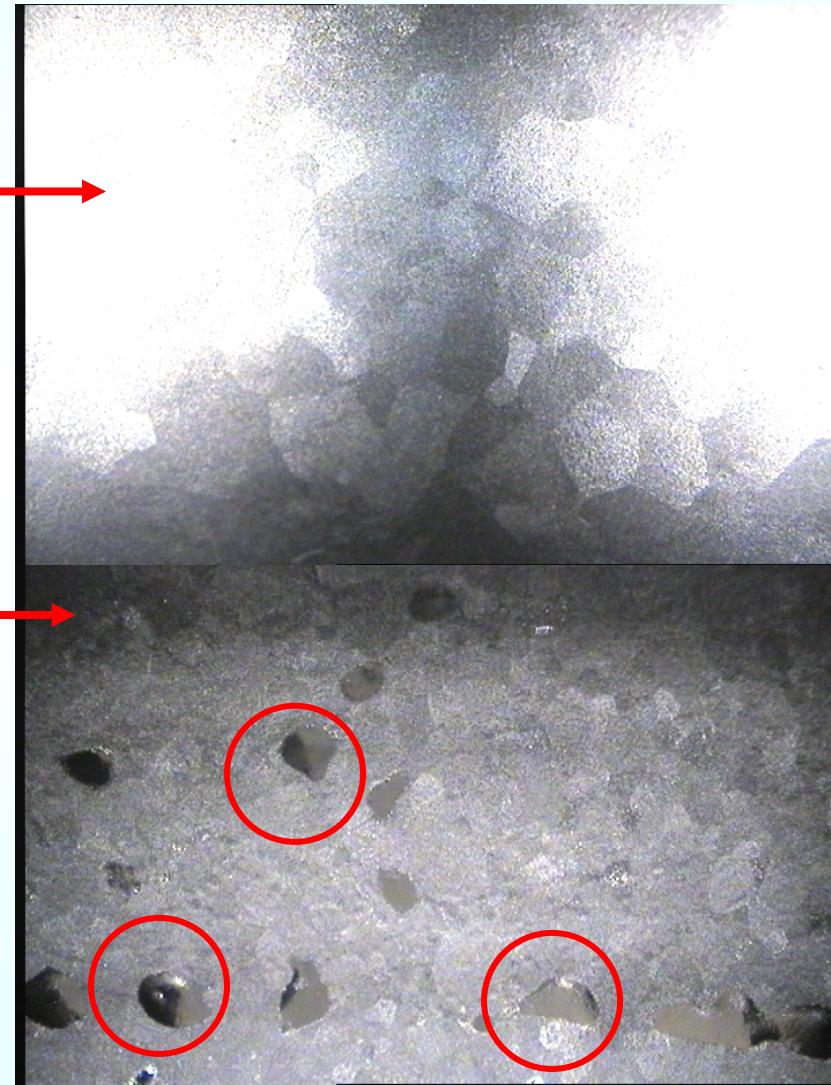
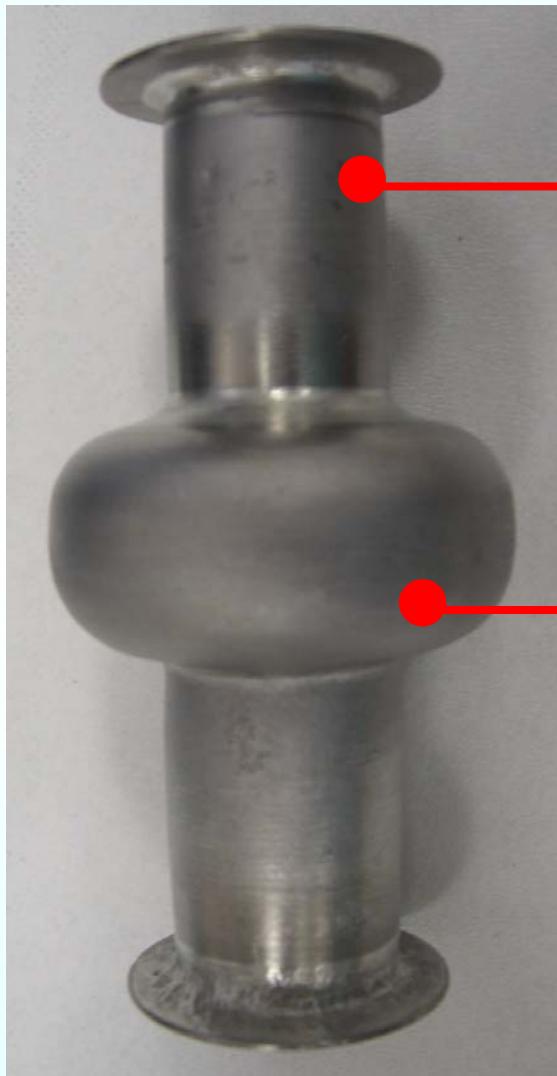
$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

## Hybrid Process: 6 GHz cavities

"Hybrid" Method for  $\text{Nb}_3\text{Sn}$  6 GHz Cavities



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

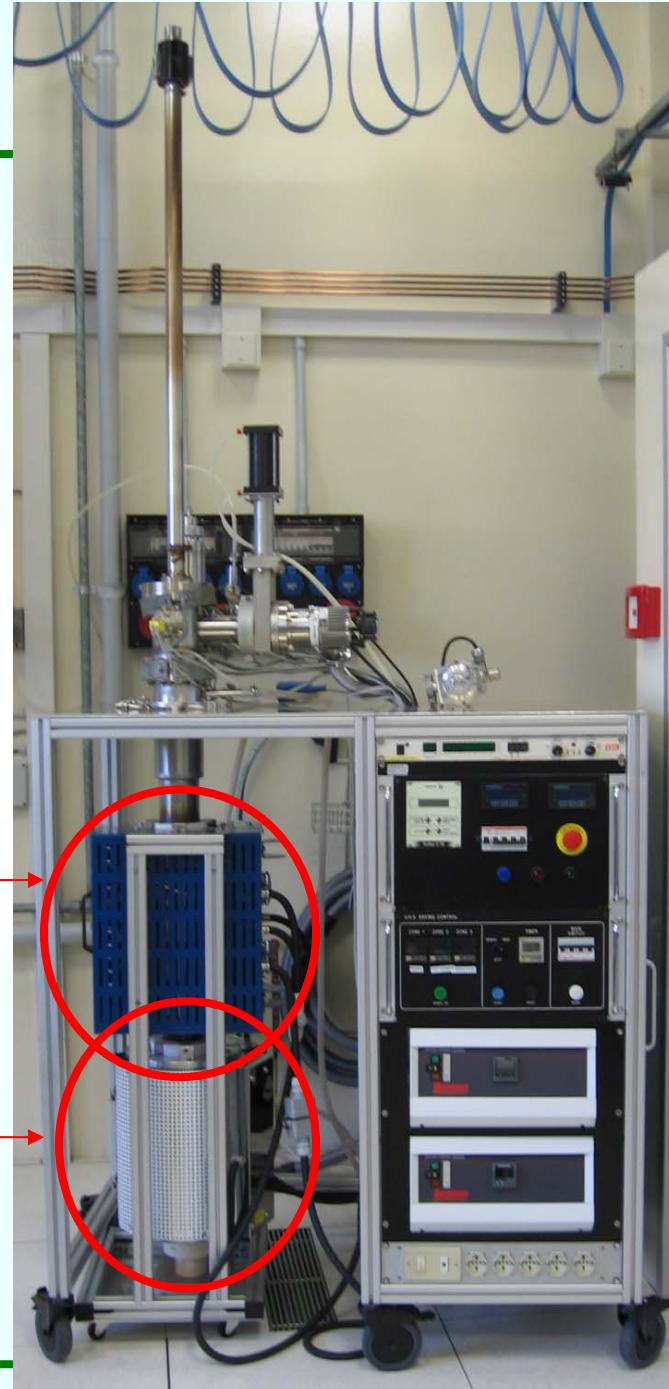
$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Double Furnace System

Built to avoid air contamination of the superconducting thin film while opening the vacuum system

Annealing Furnace

Dipping Furnace



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

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Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

## Mechanical Plating

Preliminary preparation:

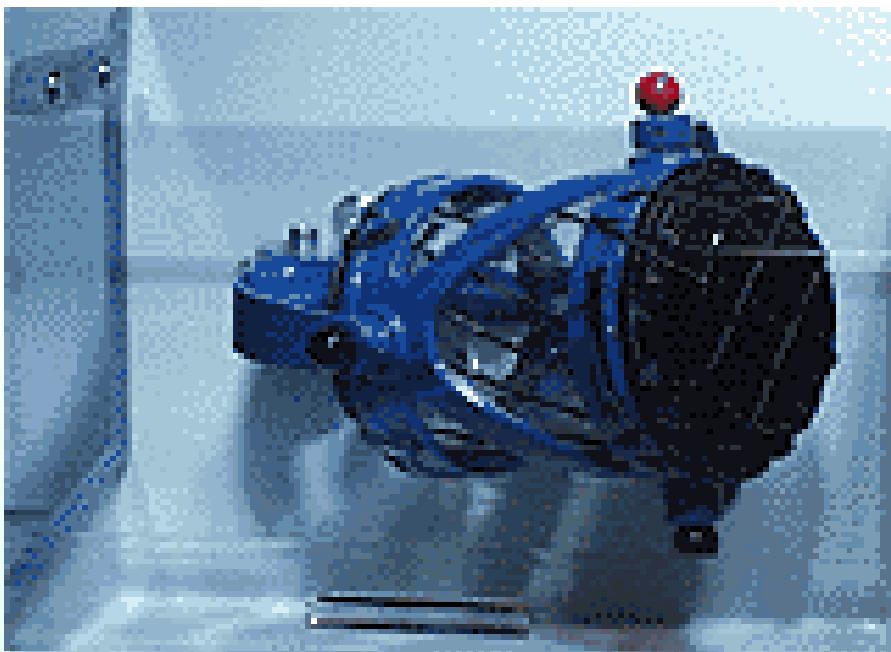
Cavity

- Mechanical etching
- Chemical etching (1:1:1)

Sn pieces

- Ultra sonic cleaning

A 6 GHz cavity in the working tumbler



Sn pieces after the treatment



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

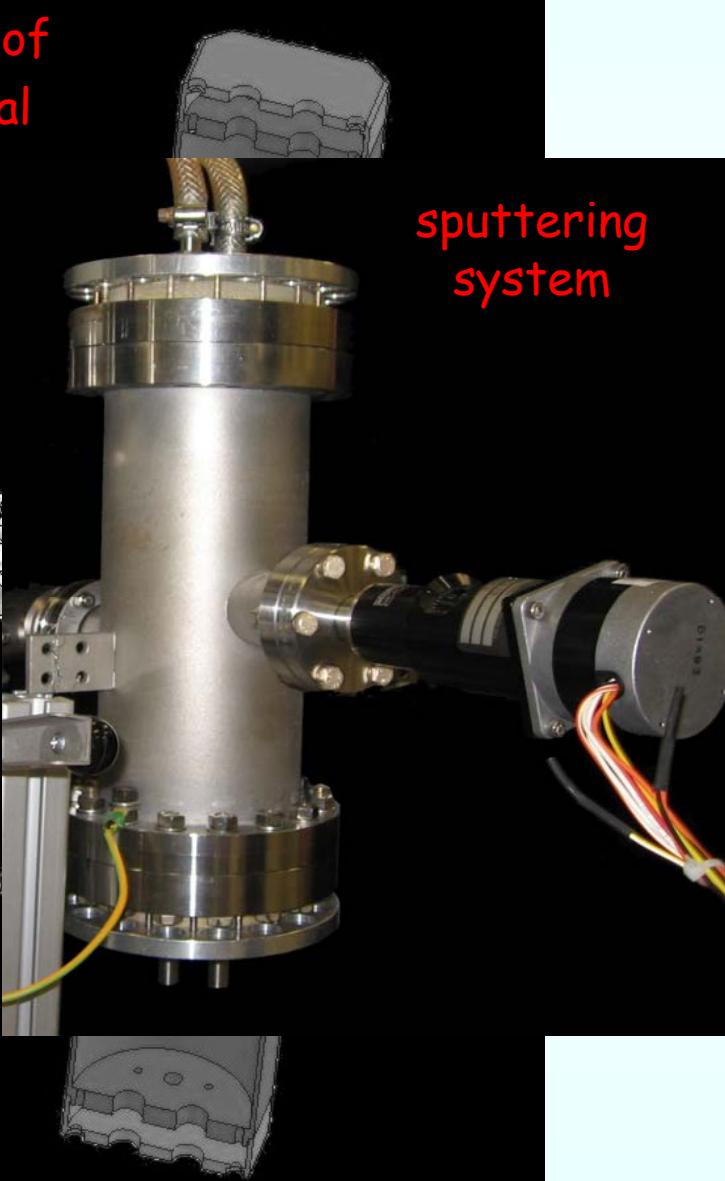
$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion +  
Plasma

## Multilayer: Double Magnetron

Section view of  
experimental  
device



- ✓ Balanced Magnetron
- ✓ Target-Substrate distance = 60 mm
- ✓ 2 inches target dia

$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

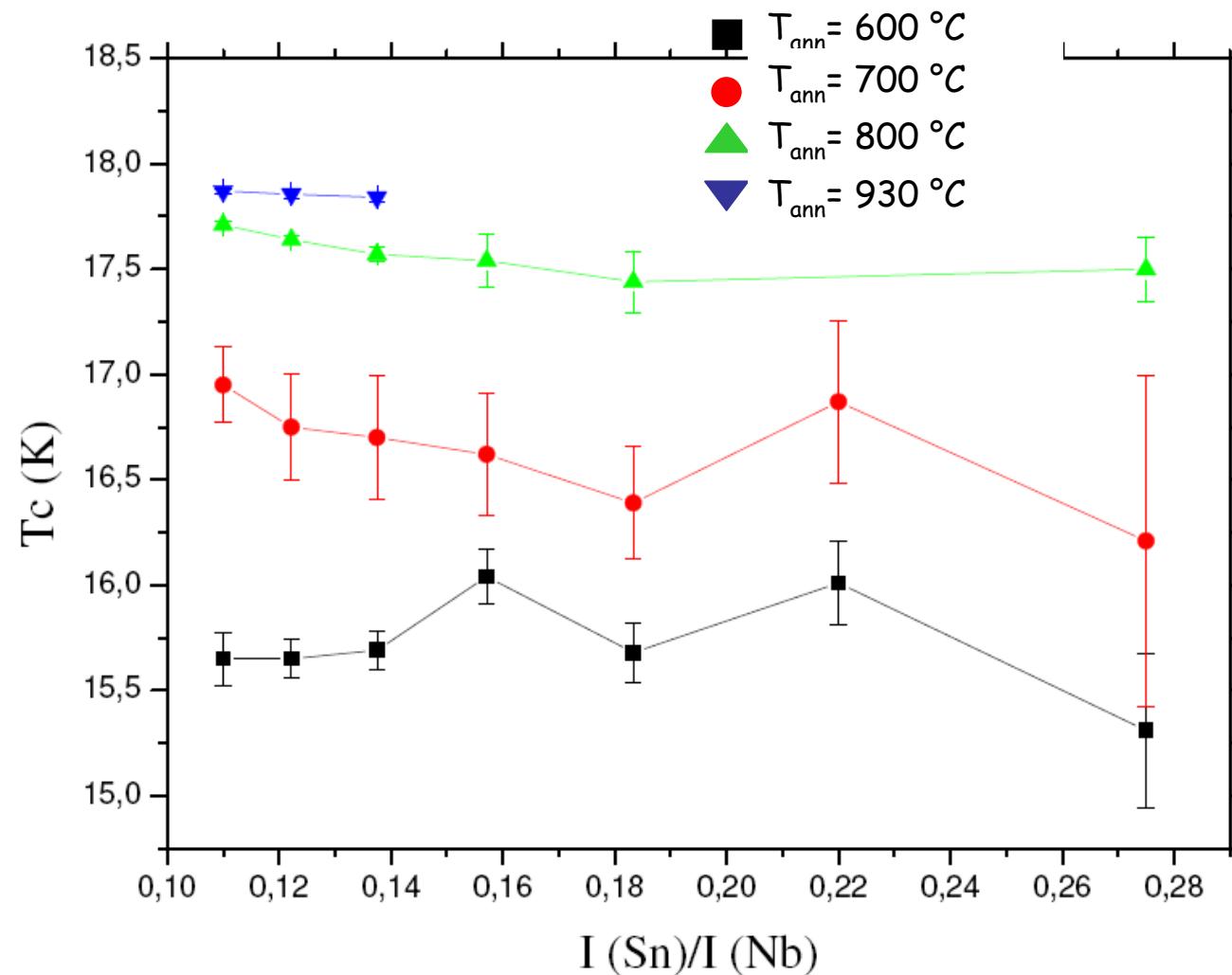
Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion +  
Plasma

## Double Magnetron: Samples



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

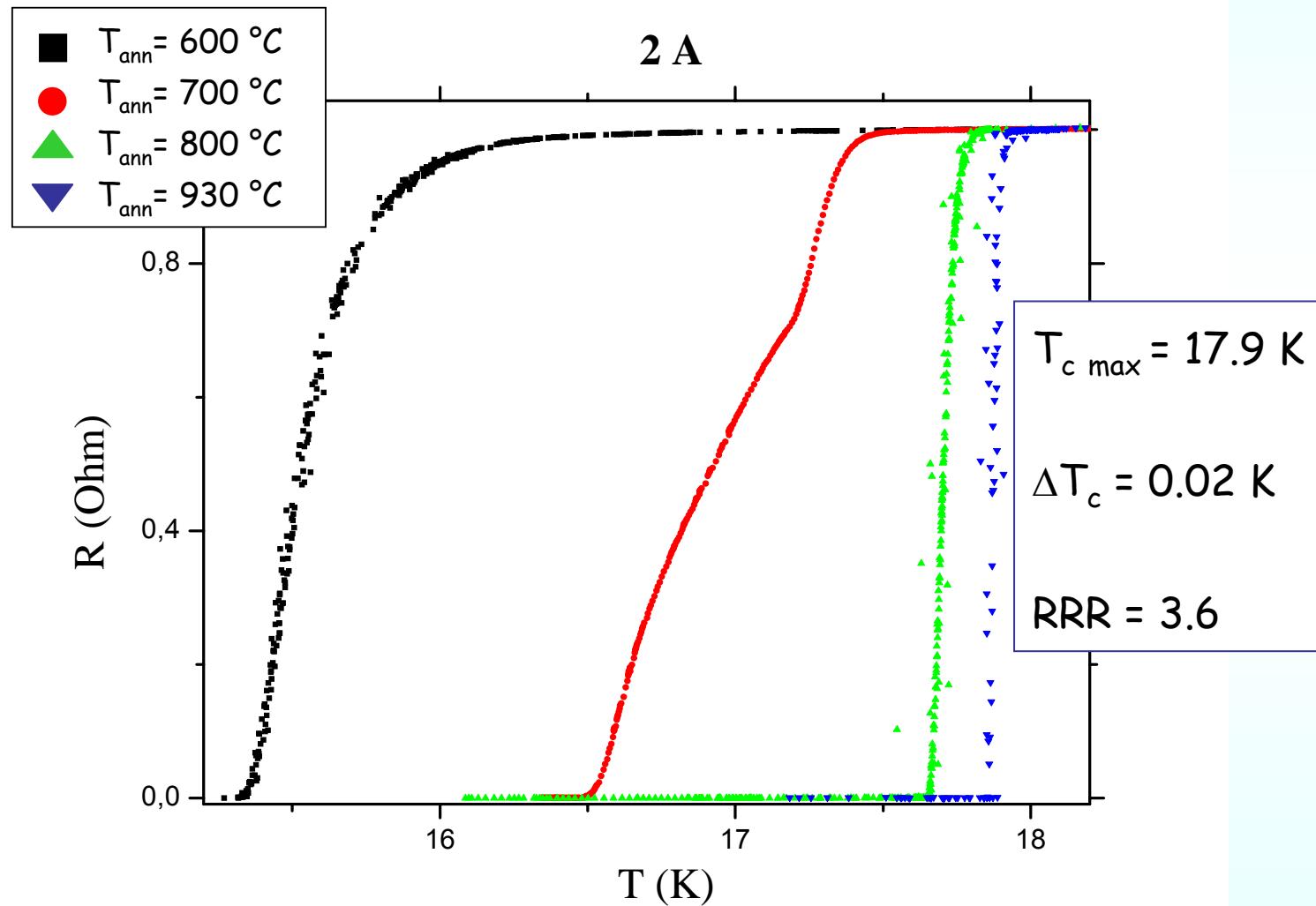
Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

## Double Magnetron: Samples



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

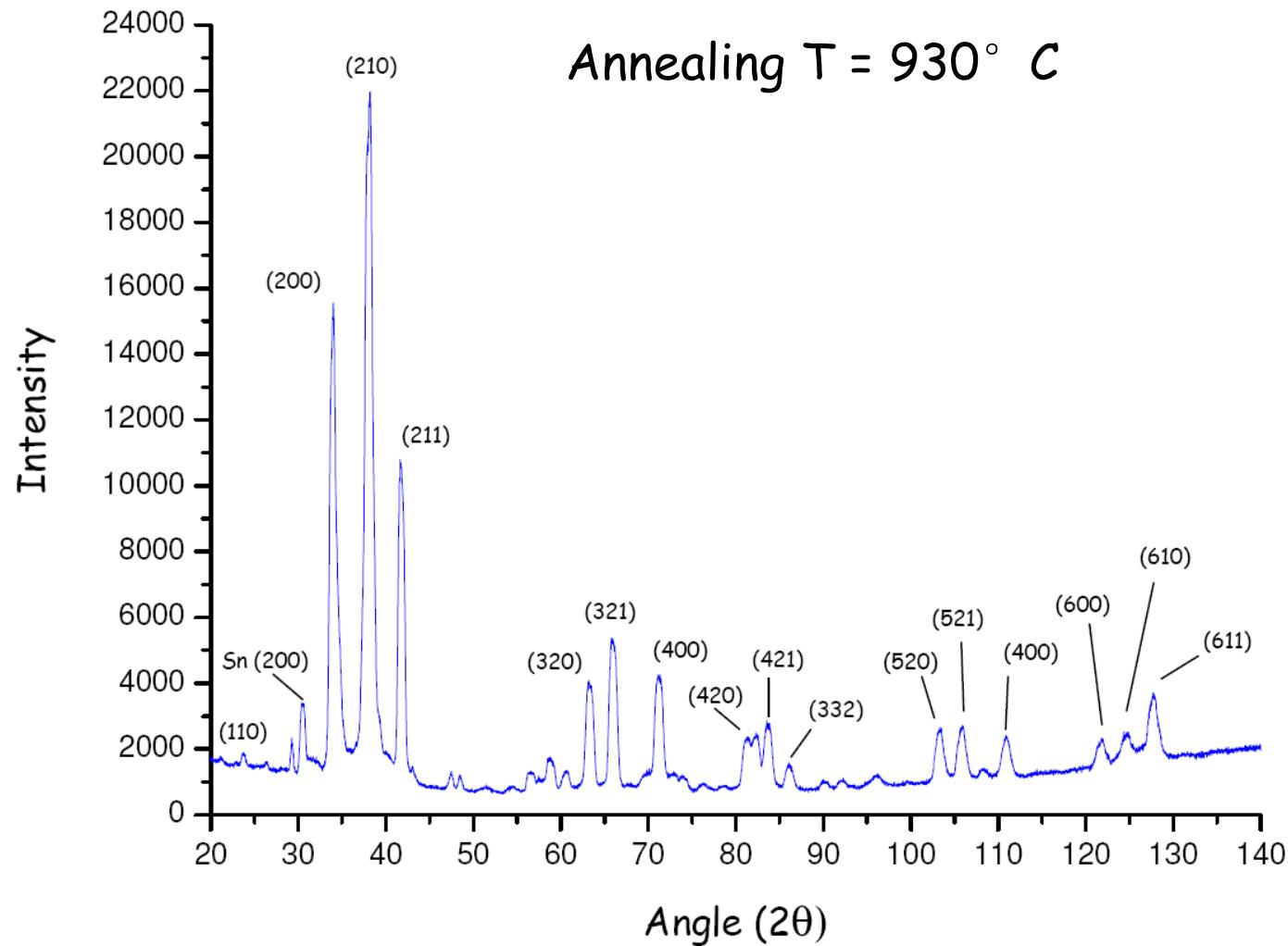
$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Double Magnetron: Samples



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

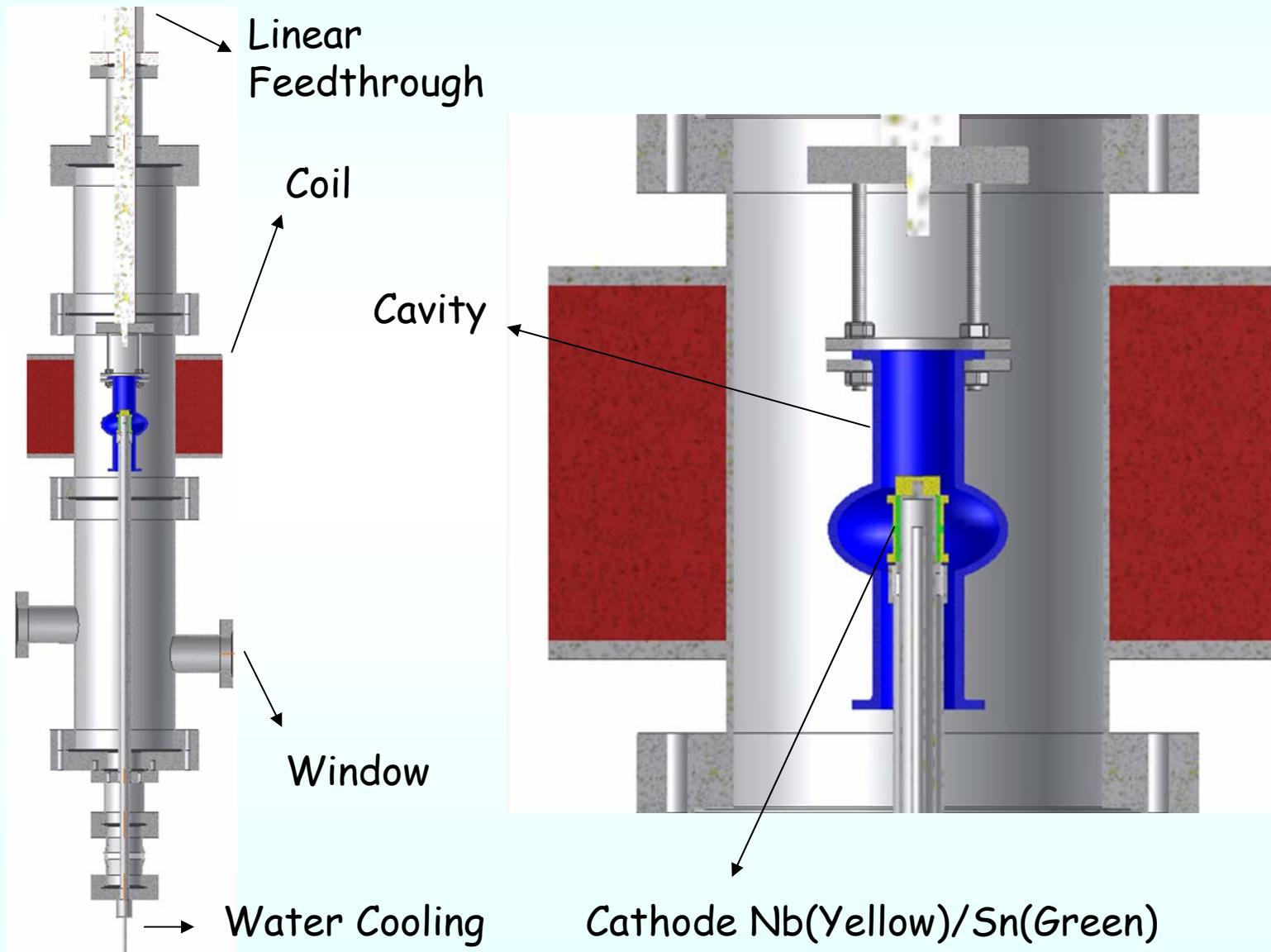
$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Post Magnetron: 6 GHz Cavities



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Post Magnetron: 6 GHz Cavities



$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

$\text{Nb}_3\text{Sn}$  -  $\text{Nb}_3\text{Sn}$  at LNL

## Post Magnetron: 6 GHz Cavities

Time of sputtering: 70 min

Annealing Time: 1 h at 850°C

Four hypotheses:

- 1) Sn evaporation due to plasma interaction with the growing film
- 2) Too thin Film
- 3) Spurious phases presence (slow annealing ramp time)
- 4) We suspect the substrate treatment requires even more attention

$\text{Nb}_3\text{Sn}$

Liquid Sn diffusion

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Double Magnetron

Post Magnetron

$\text{V}_3\text{Si}$

Thermal diffusion

Thermal Diffusion + Plasma

$V_3Si$  -  $V_3Si$  at LNL

## Thermal Diffusion

Research for the best Chemical Treatment of V

- $SiH_4$  Decomposition
- Si Diffusion
- $V_3Si$  Nucleation
- Film Growing
- Recrystallization
- $H_2$  Removal

Variables: T, t, p( $SiH_4$ )

$Nb_3Sn$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

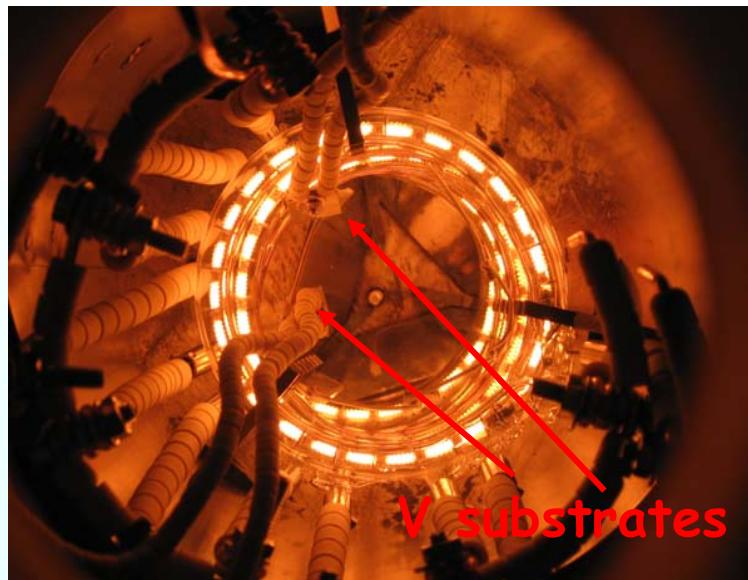
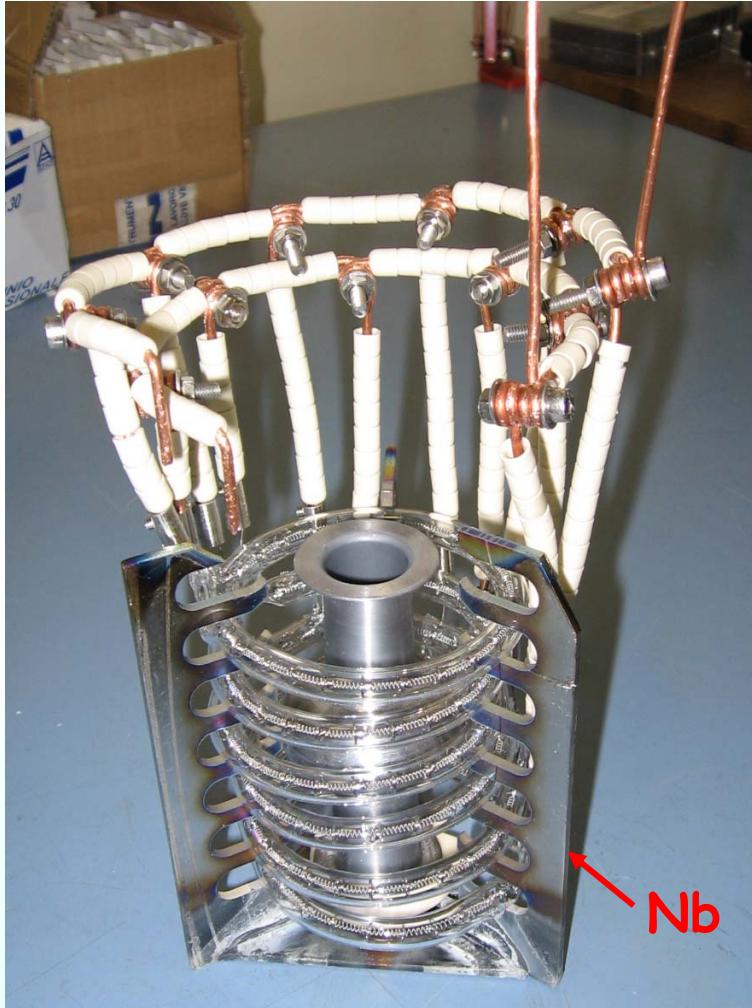
$V_3Si$

Thermal diffusion

Thermal Diffusion +  
Plasma

$V_3Si$  -  $V_3Si$  at LNL

## Thermal Diffusion: Experimental SetUp



$Nb_3Sn$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

$V_3Si$

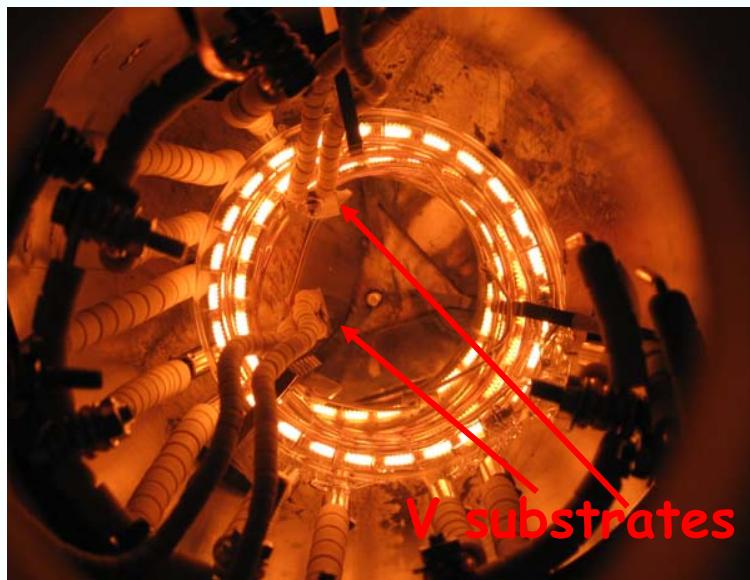
Thermal diffusion

Thermal Diffusion + Plasma

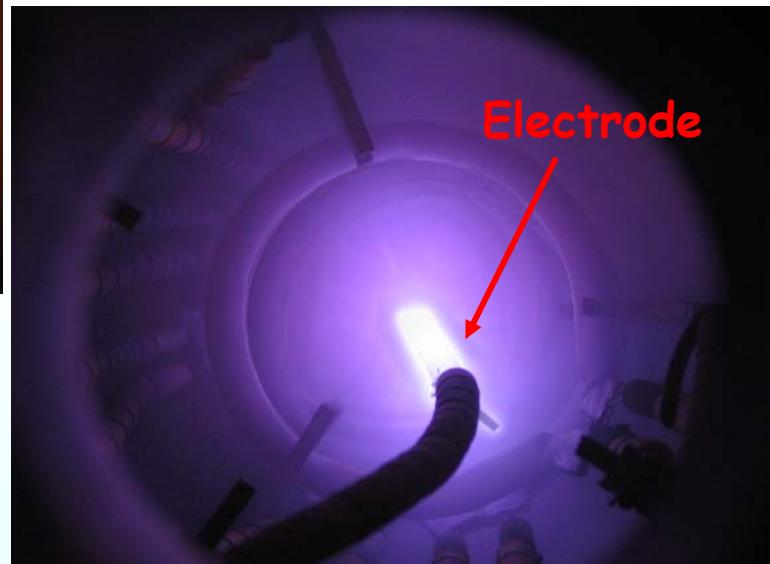
$V_3Si$  -  $V_3Si$  at LNL

## Thermal Diffusion + Plasma: Experimental SetUp

Lamps on



Plasma on



$Nb_3Sn$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

$V_3Si$

Thermal diffusion

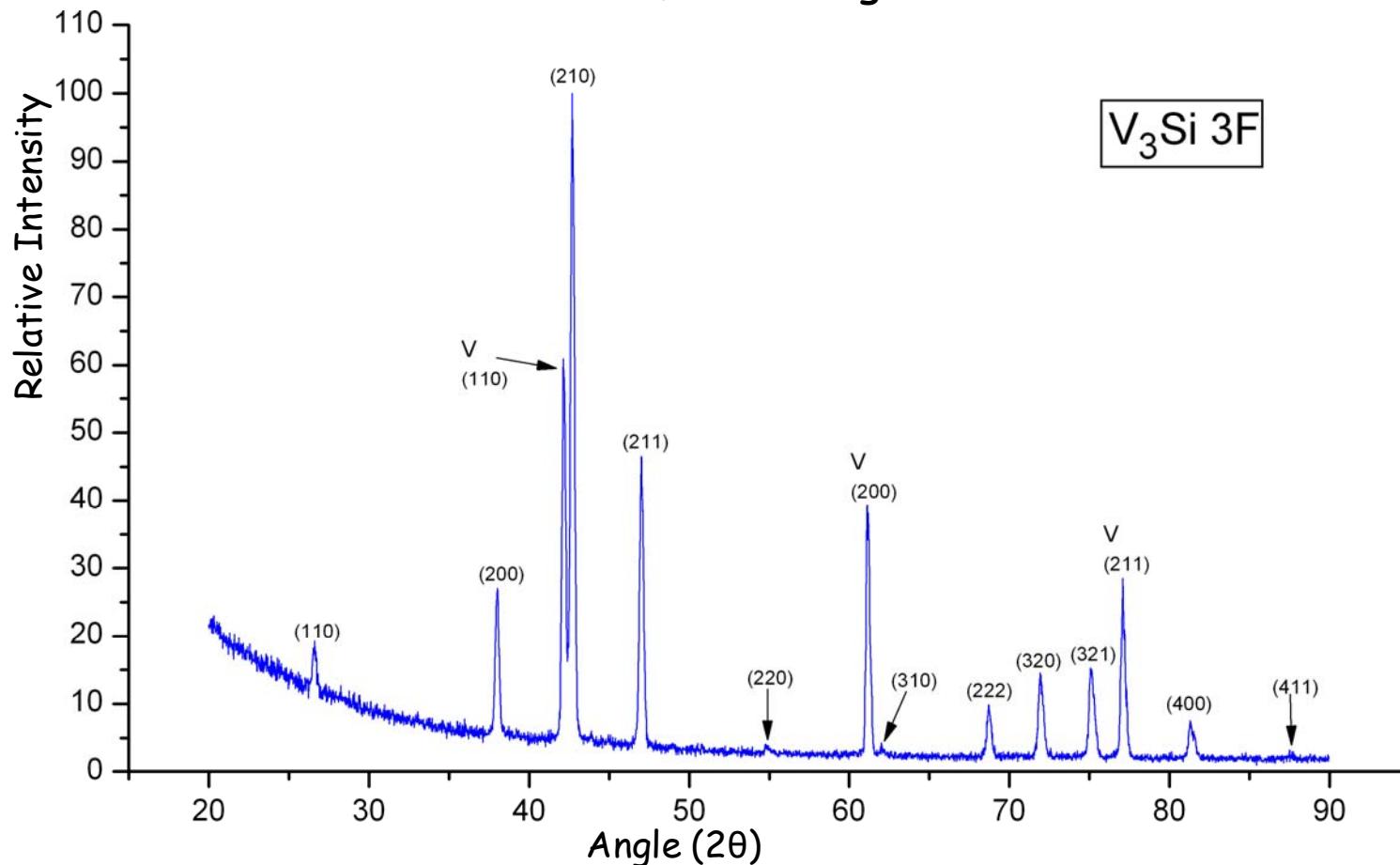
Thermal Diffusion +  
Plasma

$V_3Si$  -  $V_3Si$  at LNL

## Thermal Diffusion: Samples

Process  $T = 825^\circ C$ ,  $p(SiH_4) = 5,0 \times 10^{-4}$  mbar

Silanization  $t = 10h$ , Annealing  $t = 20h$



Nb<sub>3</sub>Sn

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

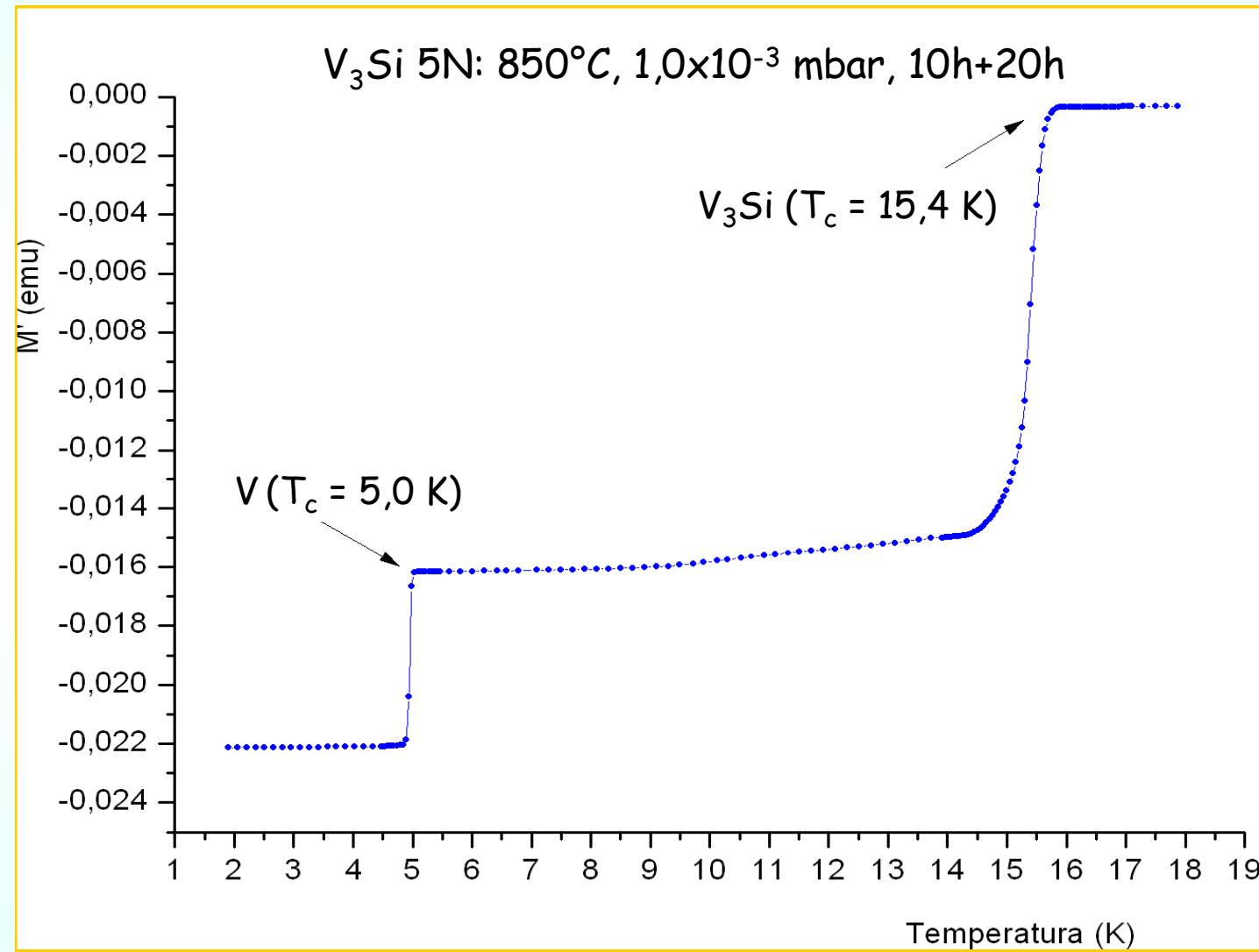
Post Magnetron

V<sub>3</sub>Si

Thermal diffusion

Thermal Diffusion + Plasma

## Thermal Diffusion: Samples



$Nb_3Sn$

Liquid Sn diffusion

Mechanical Plating

Double Magnetron

Post Magnetron

$V_3Si$

Thermal diffusion

Thermal Diffusion + Plasma

## Summary

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1) Sn diffusion:

$$T_c = 16.8 \text{ K}, \Delta T_c = 0.16 \text{ K},$$

Nb<sub>3</sub>Sn 6 GHz cavities has been produced

2) Multilayer:

Double Magnetron:  $T_c = 17.9 \text{ K}, \Delta T_c = 0.02 \text{ K}$

Post Magnetron: the first Nb<sub>3</sub>Sn 6 GHz cavity has been measured

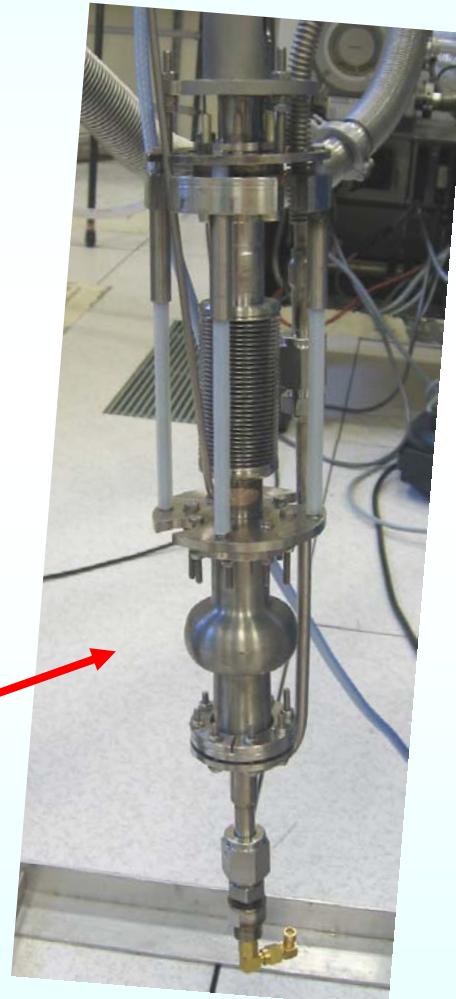


1) Plasma Silanization:

$$T_c = 15.7 \text{ K}, \Delta T_c = 0.2 \text{ K}$$

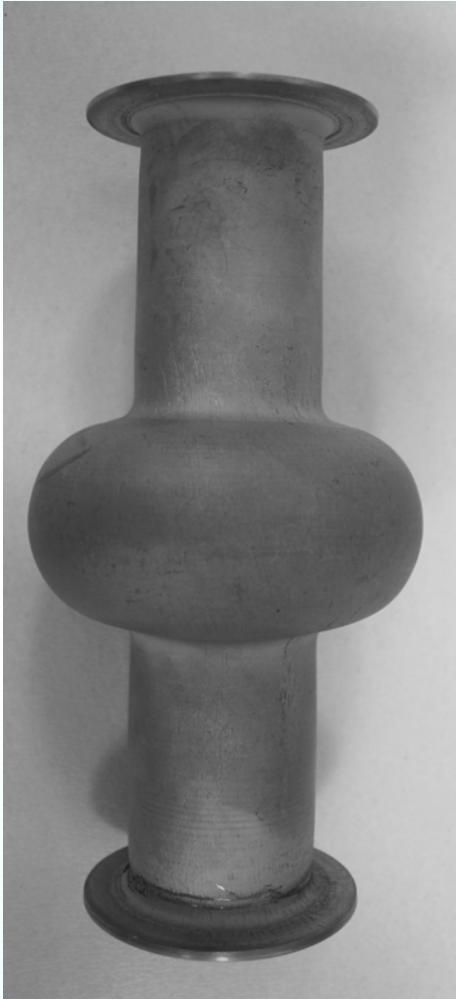
2) V<sub>3</sub>Si 6 GHz cavity obtained: Work in progress

# Good News Allen: 6 GHz Cavities



## 6 GHz Cavities

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- 80 cavities are under fabrication using Scrap Nb
- Flanges are **seamless**: no brazing, no EB welding
- It is possible to perform more than one RF test a day

The End

**NO SAMPLE IS COMPARABLE TO A CAVITY!**